

Technical Data Sheet

THICK FILM MATERIALS

Product Type: End Terminations

Product Name: ET1856



Solderable and Plateable Silver/ Palladium End Termination

Description

ET1856 is a Pb and Cd free solderable & nickel plateable silver/palladium (4:1) end termination designed to be compatible on Multilayer ceramic chip capacitors (NPO and X7R bodies). Nickel plating can be done without pre-plate processing due to the low glass content on the fired surface.

Key Benefits

- Nickel plateable no pre-plate processing
- Low usage excellent coverage uniformity
- Dense fired microstructure
- Cu plateable
- Pb and Cd free

Typical Properties

Viscosity

30 – 40 Kcps Brookfield RVT
SC4 – 14 spindle, 6R utility cup at 10 rpm, 25 °C

Solids

76.5 ± 1.5 %

Solderability

Sn62/Pb36/Ag2 at 230 °C
5 second dip, RMA flux

Sn6/Pb40 at 250 °C,
5 second dip, RMA flux

FOG

≤ 10 µm (at 4th scratch)

Recommended Processing Guidelines

Drying

150 °C for 10 minutes
20 minute total cycle time

Firing

650 – 800 °C peak temperature
Dwell time at temp. 5 – 7 minutes

Thinner:

RV-372

Warranty:

Material guaranteed to meet specifications for 6 months from date of shipment.

Storage:

Store in a dry location at 5 – 25 °C.

DO NOT REFRIGERATE.

Allow paste to come to room temperature prior to opening.
Spatulate well before using, as settling may occur during storage.

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